

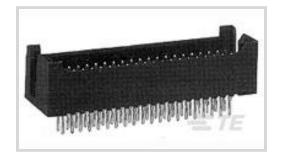
### AMPMODU | AMPMODU Headers

TE Internal #: 5-102567-1 PCB Mount Header, Vertical, Board-to-Board, 12 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, AMPMODU Headers

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: **12** 

Number of Rows: 2

# Features

### Product Type Features

PCB Connector Assembly Type

Connector System

Header Type

PCB Mount Header

Board-to-Board

Fully Shrouded

Printed Circuit Board

### **Configuration Features**

PCB Mount Orientation	Vertical	
Number of Positions	12	
Number of Rows	2	
Board-to-Board Configuration	Parallel	
Electrical Characteristics		
Termination Resistance	12 mΩ	
Operating Voltage	250 VAC	
Body Features		
Primary Product Color	Black	
Contact Features		
Mating Square Post Dimension	.64 mm[.025 in]	
	100 µin	
Contact Shape & Form	Square	

**C** For support call+1 800 522 6752

PCB Mount Header, Vertical, Board-to-Board, 12 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, AMPMODU Headers



PCB Contact Termination Area Plating Material	Tin	
Contact Base Material	Copper Alloy	
Contact Mating Area Plating Material	Gold	
Contact Mating Area Plating Material Thickness	.381 µm[15 µin]	
Contact Type	Pin	
Contact Current Rating (Max)	3 A	
Termination Features		
Square Termination Post & Tail Dimension	.64 mm[.025 in]	
Termination Post & Tail Length	4.57 mm[.18 in]	
Termination Method to Printed Circuit Board	Through Hole - Solder	
Mechanical Attachment		
Mating Retention	Without	
Mating Alignment	With	
Mating Alignment Type	Guide Pins	
PCB Mount Retention	Without	
PCB Mount Alignment	Without	
Connector Mounting Type	Board Mount	

### Housing Features

Centerline (Pitch)	2.54 mm[.1 in]	
Housing Material	Thermoplastic	
Dimensions		
Connector Height	13.97 mm[.55 in]	
Row-to-Row Spacing	2.54 mm[.1 in]	
Stack Height	11.43 mm[.45 in]	
PCB Thickness (Recommended)	1.4 mm[.055 in]	
Usage Conditions		
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]	
Operation/Application		
Solder Process Feature	Board Standoff	
Circuit Application	Signal	
Industry Standards		
Approved Standards	CSA LE7189, UL E28476	

**C** For support call+1 800 522 6752

PCB Mount Header, Vertical, Board-to-Board, 12 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, AMPMODU Headers



UL Flammability Rating	UL 94V-0	
Packaging Features		
Packaging Quantity	80	
Packaging Type	Tube	
Product Compliance For compliance documentation, visit the product page on TE.com>		
EU RoHS Directive 2011/65/EU	Compliant	
EU ELV Directive 2000/53/EC	Compliant	
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold	
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC	
Halogen Content	BFR/CFR/PVC Free, but Br/Cl >900 ppm in other sources.	
Solder Process Capability	Not applicable for solder process capability	

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# **Compatible Parts**



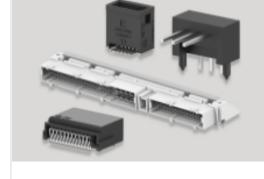
PCB Mount Header, Vertical, Board-to-Board, 12 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, AMPMODU Headers



# Also in the Series AMPMODU Headers

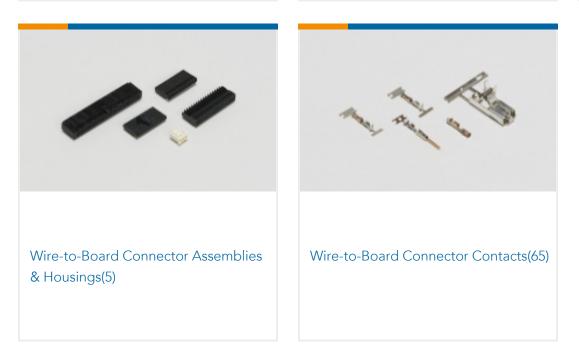






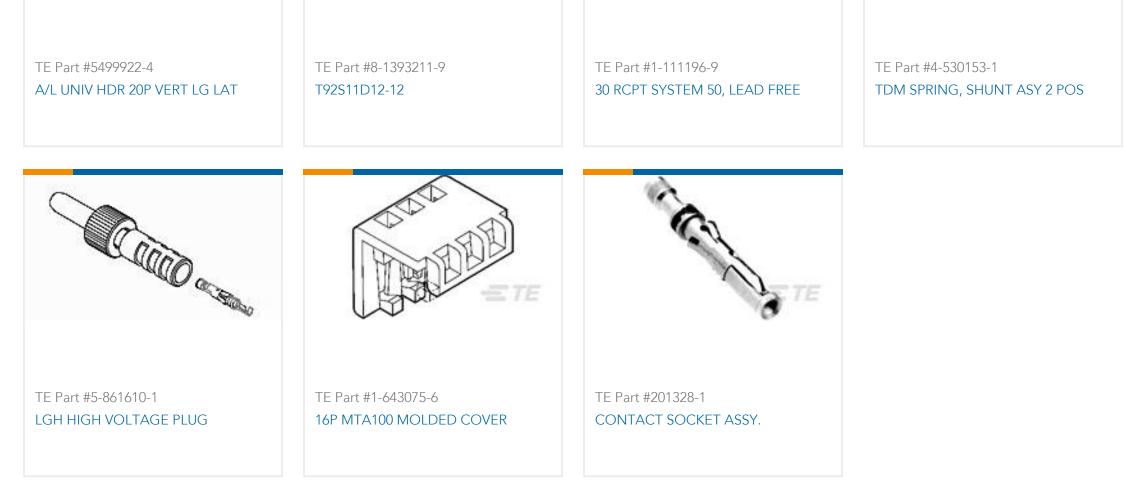


PCB Connector Mounting(1)	PCB Headers & Receptacles(4871)	PCB Latches, Locks & Retainers(1)



# Customers Also Bought





# Documents

Product Drawings 12 MODII 2PC HDR DR SHRD .100, ROHS

English

### **CAD** Files

Customer View Model ENG\_CVM\_5-102567-1\_N3.3d\_igs.zip

PCB Mount Header, Vertical, Board-to-Board, 12 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, AMPMODU Headers



English Customer View Model ENG\_CVM\_5-102567-1\_N3.3d\_stp.zip English 3D PDF 3D D PDF English Customer View Model ENG\_CVM\_5-102567-1\_N3.2d\_dxf.zip English

# Datasheets & Catalog Pages AMPMODU\_INTERCONNECTION\_SYSTEM\_SECTION5\_CONT

English

Product Environmental Compliance TE Material Declaration

English